



Product Change Notification

113170 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113170 - 00
Change Title: Intel® Server System R2208GZ4GC
PCN 113170-00, Product Design
Update Rear Panel, Fan bulkhead, eUSB SSD
stand-off and Add two ground studs
Date of Publication: July 28, 2014

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	Effective immediately
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel has implemented the following changes on the Intel® Server System R2208GZ4GC:

1. Add a small cut-out to the system rear panel to provide better clearance for latches on network cables plugging into the dual-port Intel® X540 10GbE I/O Module AXX10GBTWLIOM.
2. Update the fan bulkhead with a more rigid version to enhance fan module stability.
3. Update the eUSB SSD stand-off with a strengthened version to hold part more securely.
4. Add two ground studs on the system rear panel for future use (see Figure 1 below).



Figure 1: The ground studs

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the changes and determine the impact on their applications.

These changes were effective November, 2012 and based on inventory levels customers will start seeing these changes now.

Products Affected / Intel Ordering Codes:

ASMO SKU			
Product Code	MM#	Pre Change TA	Post Change TA
R2208GZ4GC	917001	G52127-003	G52127-004

PCN Revision History:

Date of Revision:

July 28, 2014

Revision Number:

00

Reason:

Originally Published PCN